

MP2016 42V, 30mA, Low Power Adjustable Output Linear Regulator

The Future of Analog IC Technology

DESCRIPTION

The MP2016 is a low power linear regulator that supplies power to systems with high voltage batteries. It includes a wide 4V to 42V input range, low dropout voltage and low quiescent supply current.

The MP2016 provides excellent line transient response time and 50dB power supply rejection ratio (PSRR). The MP2016 can be set externally from 1.2V to 40V through a simple resistor divider network.

The MP2016 also includes thermal shutdown and current limiting fault protection. It is available in TSOT23-5 and QFN-8 packages.

FEATURES

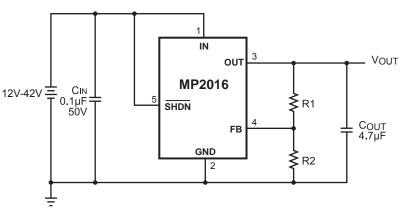
- 4V to 42V Input Range
- 12µA Quiescent Supply Current
- <1.5µA Shutdown Current
- 1.2V to 40V Adjustable Output
- 30mA Output Current with 50mA Peak
 Current Limit
- ±2% Accuracy
- Thermal Shutdown
- Available in Tiny TSOT23-5 and QFN-8 Packages

APPLICATIONS

- Notebook Computers
- Smart-Battery Packs
- PDAs
- Handheld Devices
- Battery-Powered Systems

For MPS green status, please visit MPS website under Quality Assurance. "MPS" and "The Future of Analog IC Technology" are Registered Trademarks of Monolithic Power Systems, Inc.

TYPICAL APPLICATION





ORDERING INFORMATION

Part Number	Package	Top Marking	Free Air Temperature (T _A)
MP2016DJ*	TSOT23-5	R2	-40°C to +85°C
MP2016DD**	QFN-8 (2 x 3mm)	R2	-40°C to +85°C

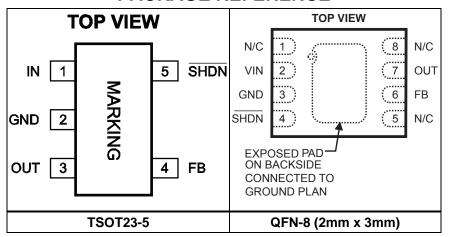
* For Tape & Reel, add suffix –Z (g. MP2016DJ–Z).

For RoHS compliant packaging, add suffix -LF (e.g. MP2016DJ-LF-Z)

** For Tape & Reel, add suffix -Z (g. MP2016DD-Z).

For RoHS compliant packaging, add suffix –LF (e.g. MP2016DD–LF–Z)

PACKAGE REFERENCE



ABSOLUTE MAXIMUM RATINGS (1)

IN, SHDN	
FB	
Continuous Power Dissipation (T	_A = +25°C) ⁽²⁾
TSOT23-5	0.6.W
QFN8 (2X3mm)	
Lead Temperature	
Storage Temperature6	65°C to +150°C

Recommended Operating Conditions ⁽³⁾

Supply Voltage V _{IN}	4V to 42V
Output Voltage Vout	
Maximum Junction Temp. (T _J)	+125°C

Thermal Resistance $^{(4)}$ θ_{JA}

TSOT23-5	 110°C/W
QFN8 (2 x 3mm)	 12 °C/W

 $\theta_{\rm IC}$

Notes:

- 2) The maximum allowable power dissipation is a function of the maximum junction temperature T_J (MAX), the junction-toambient thermal resistance θ_{JA} , and the ambient temperature T_A. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P_D (MAX) = (T_J (MAX)-T_A)/ θ_{JA} . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) Measured on JESD51-7, 4-layer PCB.

¹⁾ Exceeding these ratings may damage the device.



ELECTRICAL CHARACTERISTICS

$V_{IN} = 15V$, $I_{LOAD} = 5\mu A$, $T_A = +25^{\circ}C$, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Input Voltage	V _{IN}		4		42	V
Input Supply Current	I _{IN}	T _A = +25°C		12		μA
		$T_A = -40^{\circ}C$ to +85°C			30	
Minimum Load Current					0	μA
	I _S	Shutdown Mode, T _A = +25°C			8	μΑ
Shutdown Supply Current		Shutdown Mode, $T_A = -40^{\circ}C$ to +85°C			10	
		FB = OUT, I _{LOAD} = 1mA	1.205	1.23	1.254	
FB Threshold	V_{FB}	FB = OUT, I_{LOAD} = 5µA to 30mA, T _A = -40°C to +85°C	1.181	1.23	1.279	V
FB Input Current	I _{FB}	V _{FB} = 1.3V	-30	+4	+30	nA
Dropout Voltage (6)	V_{DROPOUT}	I _{LOAD} = 30mA		700	900	mV
PSRR		DC, I _{OUT} =10mA		65		dB
Current Limit		V _{IN} = 6V		50		mA
Ground current		I _{OUT} =35mA		35		μA
Capacitive Load Requirements			0.23			µF/mA
Startup Response Time		R_L = 500 Ω , C2 = 6.8 μ F, V _{OUT} = 5V			1	ms
Startup Overshoot	V _{OSH}	R_L = 500 Ω , C2 = 10 μ F within 90% of the nominal output voltage		0.58		% V _{OUT}
SHDN Input Threshold	V _{IL}				0.22	V
Voltage	V _{IH}		1.8			v
SHDN Input Current		SHDN = 0V or 15V		0.6	1.5	μA
Line Regulation				0.023		%/V
Load Regulation				0.003		%/mA
Thermal Shutdown		SHDN= 0V or 15V,Hysteresis = +20°C		150		°C

Note:

5) 100% production tested at TA=25°C Specifications over the temperature range are guaranteed by design and characterization.

6) Dropout Voltage is defined as the in put to output differential when the output voltage drops 1% below its nominal value.

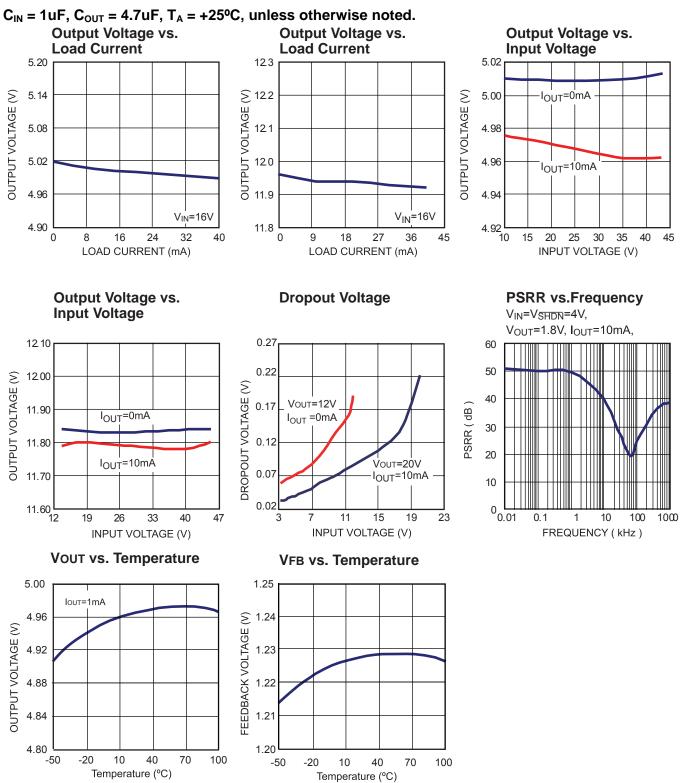


PIN FUNCTIONS

QFN Pin #	TSOT23 Pin #	Name	Description
2	1	VIN	Input Voltage. Connect a 4V to 42V supply to this pin.
3	2	GND, Exposed Pad	Ground (the exposed pad and GND pin must be connected to the same ground plane for QFN package).
7	3	OUT	Regulator Output.
6	4	FB	Feedback. This is the feedback input pin, regulated to 1.23V nominally.
4	5	SHDN	Shutdown. A logic LOW on this pin will shut down the IC; a logic HIGH will start it up. Connect this pin to IN for automatic startup.
1, 5, 8		N/C	No Connect.

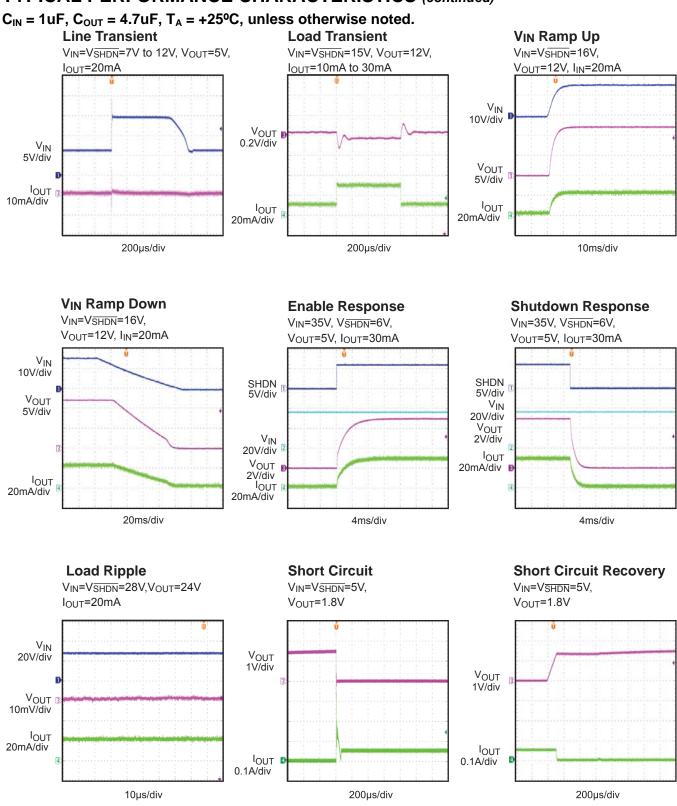


TYPICAL PERFORMANCE CHARACTERISTICS



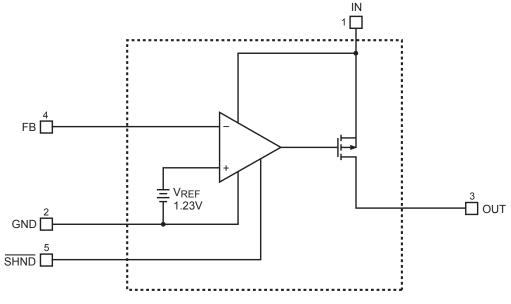


TYPICAL PERFORMANCE CHARACTERISTICS (continued)





OPERATION





The MP2016 is a linear regulator designed primarily for high input voltage applications. The MP2016 has an output that is adjustable from 1.2V to 40V with a simple resistor divider. The maximum power output current is a function of the package's maximum power dissipation for a given temperature.

The MP2016 uses external feedback, allowing the user to set the output voltage with an external resistor divider. The typical FB pin threshold is 1.23V.

The IC enters shutdown mode when \overline{SHDN} is low. In shutdown mode, the pass transistor, control circuitry, reference and all biases turn off, reducing the supply current to <2µA. Connect \overline{SHDN} to IN for automatic startup. The peak output current is limited to 50mA, which exceeds the 30mA recommended continuous output current. The output can be shorted to ground for 30 seconds without damaging the part.

When the junction temperature is too high, the thermal sensor sends a signal to the control logic that will shutdown the IC. The IC will restart when the temperature has sufficiently cooleds.

The maximum power dissipation is dependent on the thermal resistance of the case and the circuit board, the temperature difference between the die junction and the ambient air, and the rate of air flow. The GND pin and Exposed Pad must be connected to the ground plane for proper dissipation.



APPLICATION INFORMATION

COMPONENT SELECTION

Setting the Output Voltage

Set the output voltage of the MP2016 by using a resistor divider as shown:

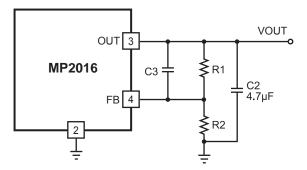


Figure 2—MP2016 with External Resistor Divider

Choose R2=250k Ω to maintain a 5µA minimum load. Calculate the value for R1 using the following equation:

$$R1 = R2 \times \left(\frac{V_{OUT}}{1.23V} - 1\right)$$

Input Capacitor

For proper operation, place a ceramic capacitor (C1) between 1μ F and 10μ F of dielectric type X5R or X7R between the input pin and ground. Larger values in this range will help improve line transient response.

Output Capacitor

For stable operation, use a ceramic capacitor (C2) of type X5R or X7R between 1μ F and 10μ F. Larger values in this range will help improve load transient response and reduce noise. Output capacitors of other dielectric types may be used, but are not recommended as their capacitance can deviate greatly from their rated value over temperature.

To improve load transient response, add a small ceramic (X5R, X7R or Y5V dielectric) 22nF feed forward capacitor in parallel with R1. The feed forward capacitor is not required for stable operation.

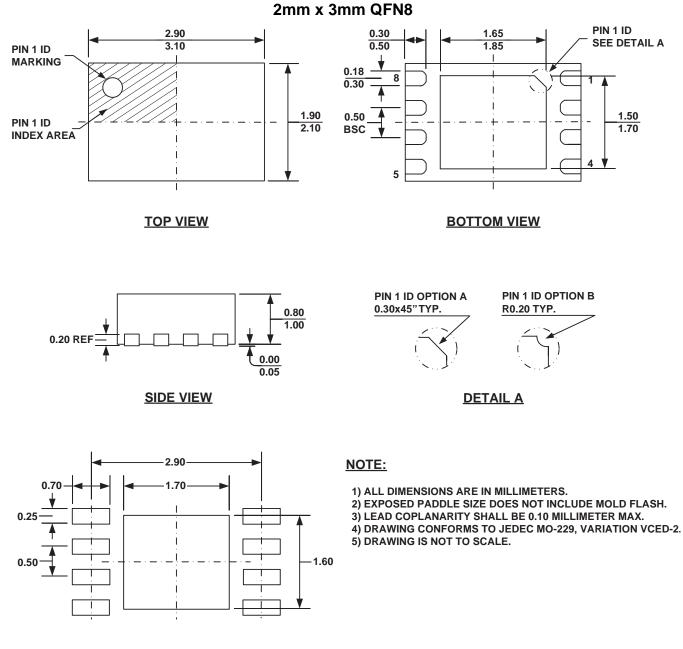
Output Noise

The MP2016 will exhibit noise on the output during normal operation. This noise is negligible for most applications. However, in applications that include analog-to-digital converters (ADCs) of more than 12 bits, one needs to consider the ADC's power supply rejection specifications.

The feed forward capacitor C3 across R1 will significantly reduce the output noise.



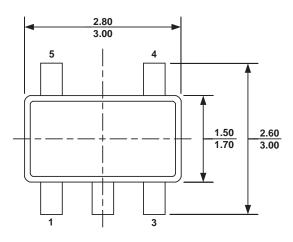
PACKAGE INFORMATION

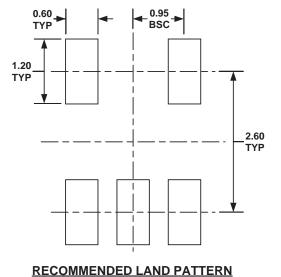




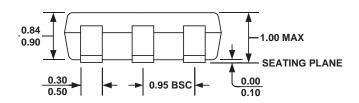


TSOT23-5

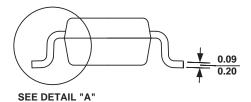




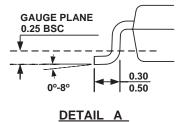
TOP VIEW



FRONT VIEW



SIDE VIEW



<u>NOTE:</u>

- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURR.
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.10 MILLIMETERS MAX.
- 5) DRAWING CONFORMS TO JEDEC MO-193, VARIATION AA.
- 6) DRAWING IS NOT TO SCALE.

NOTICE: The information in this document is subject to change without notice. Users should warrant and guarantee that third party Intellectual Property rights are not infringed upon when integrating MPS products into any application. MPS will not assume any legal responsibility for any said applications.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for LDO Voltage Regulators category:

Click to view products by Monolithic Power Systems manufacturer:

Other Similar products are found below :

AP7363-SP-13 L79M05TL-E PT7M8202B12TA5EX TCR3DF185,LM(CT TCR3DF24,LM(CT TCR3DF285,LM(CT TCR3DF31,LM(CT TCR3DF31,LM(CT TCR3DF45,LM(CT MP2013GQ-33-Z 059985X NCP4687DH15T1G 701326R TCR2EN28,LF(S NCV8170AXV250T2G TCR3DF27,LM(CT TCR3DF19,LM(CT TCR3DF125,LM(CT TCR2EN18,LF(S AP2112R5A-3.3TRG1 AP7315-25W5-7 IFX30081LDVGRNXUMA1 NCV47411PAAJR2G AP2113KTR-G1 AP2111H-1.2TRG1 ZLD01117QK50TC AZ1117IH-1.8TRG1 AZ1117ID-ADJTRG1 TCR3DG12,LF MIC5514-3.3YMT-T5 MIC5512-1.2YMT-T5 MIC5317-2.8YM5-T5 SCD7912BTG NCP154MX180270TAG SCD33269T-5.0G NCV8170BMX330TCG NCV8170AMX120TCG NCP706ABMX300TAG NCP153MX330180TCG NCP114BMX075TCG MC33269T-3.5G CAT6243-ADJCMT5T TCR3DG33,LF AP2127N-1.0TRG1 TCR4DG35,LF LT1117CST-3.3 LT1117CST-5 TAR5S15U(TE85L,F) TAR5S18U(TE85L,F) TCR3UG19A,LF TCR4DG105,LF